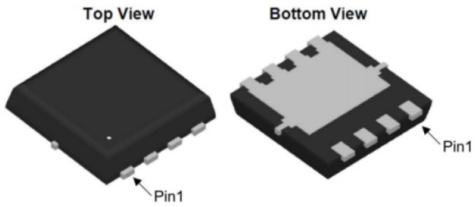
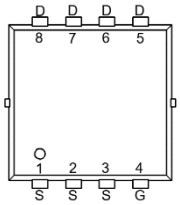
35V_{DS}/±20V_{GS} N-Channel Enhancement Mode MOSFET

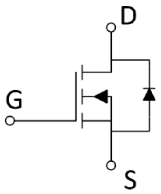
Features

- V_{DS}=35V,I_D=140A
- $R_{DS(ON)}$=3mΩ（TYP.）V_{GS}=10V
- Reliable and Rugged
- Avalanche Rated
- Low On-Resistance
- High Current Capability

PDFN5060







Applications

- Load Switch
- Power management in portable/desktop PCs
- DC/DC conversion

Ordering Information

Device	package	Device Marking	Package Qty.
JMSH0401CG	PDFN5060	SH0401CG	5000/PCS

Absolute Maximum Ratings (T$_C$=25℃,unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V_{GS}=0V)	V_{DS}	35	V
Gate-Source Voltage (V_{GS}=0V,static)	V_{GS}	±20	V
Continuous Drain Current (T$_C$=25℃)	I_D	140	A
Continuous Drain Current (T$_C$=100℃)		70	A
Pulesd Drain Current	I_{DM}	200	A
Single Pulsed Avalanche Energy	E_{AS}	150	mJ
V_{DS} Spike 100ns	V_{SPIKE}	33	V
Maximum Power Dissipation (T$_C$ =25℃)	P_D	70	W
Operating,Storage Temperature Range	T_J,T_{STG}	-55~150	℃

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	-	2.3	-	℃/ W

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V,I_D=250μA	35	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=30V, V_{GS}=0V	-	-	1	μA
Gate -Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS}=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS},I_D=250μA	2.2	3	4	V
Drain-Source On-stage Resistance	$R_{DS(ON)}$	V_{GS}=10V,I_D=20A	-	2.4	4	mΩ
		V_{GS}=4.5V,I_D=20A	-	4.2	7	

Dynamic Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C_{iss}	V_{DS}=15V	-	1580	-	pF
Output capacitance	C_{oss}	V_{GS}=0V	-	314	-	
Reverse transfer capacitance	C_{rss}	f=1MHz	-	162	-	
Gate Resistance	R_g	f=1MHz	-	1.5	-	Ω
Total Gate Charge	Q_g	V_{DS}=15V	-	36.8	-	nC
Gate Source Charge	Q_{gs}	V_{GS}=10V	-	5.3	-	
Gate Drain Charge	Q_{gd}	I_D=20A	-	5	-	
Turn-on delay Time	$t_{d(on)}$	V_{GS}=10V	-	11	-	ns
Rise time	t_r	V_{DS}=15V	-	8	-	
Turn-off delay Time	$t_{d(off)}$	R_L=0.75Ω	-	46	-	
Fall time	t_f	R_G=3Ω	-	8	-	

Reverse Diode Characteristics

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Body Diode Forward Voltage	V_{SD}	V_{GS}=0V,I_{SD}=1A	-	-	1.1	V
Reverse Recovery Time	t_{rr}	V_{GS}=0V,I_{SD}=20A	-	25	-	ns
Reverse Recovery Charge	Q_{rr}	d_i/d_t=500A/μs	-	50	-	nC

Electrical Characteristics Diagrames

Figure 1. On-Regin Characteristics

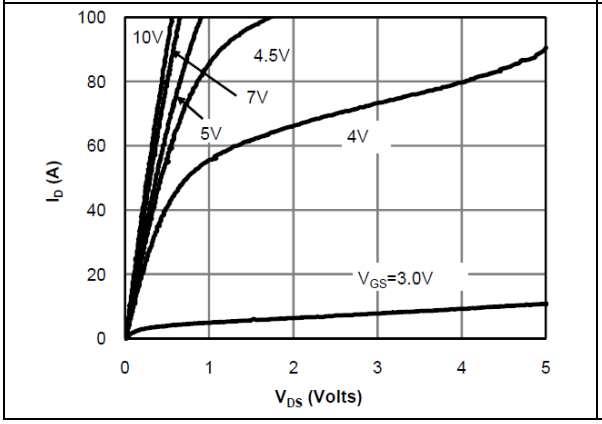


Figure 2. Transfer Characteristics

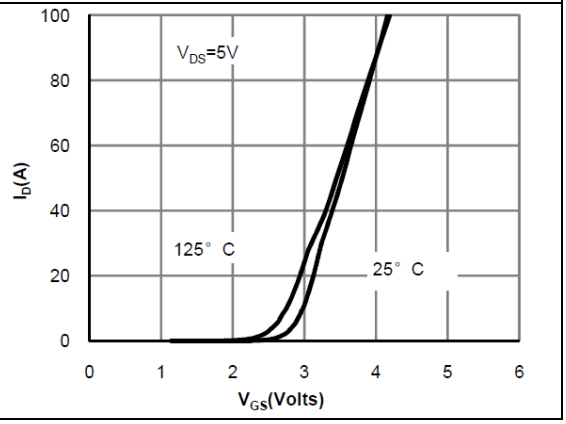


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

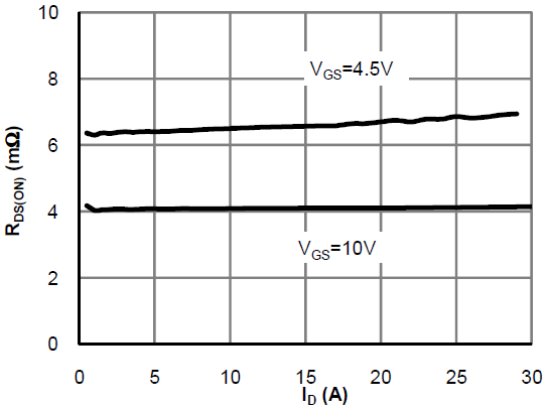


Figure 4. On-Resistance vs. Junction Temperature

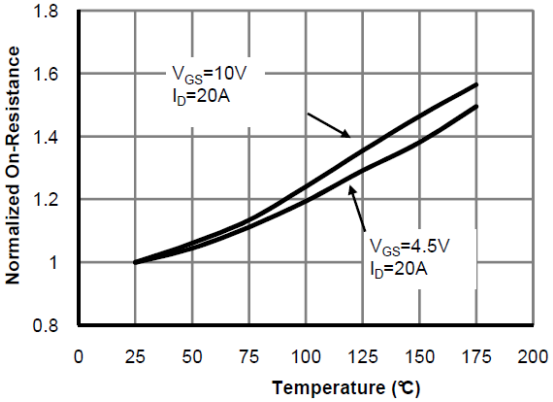


Figure 5. On-Resistance vs. Gate-Source Voltage

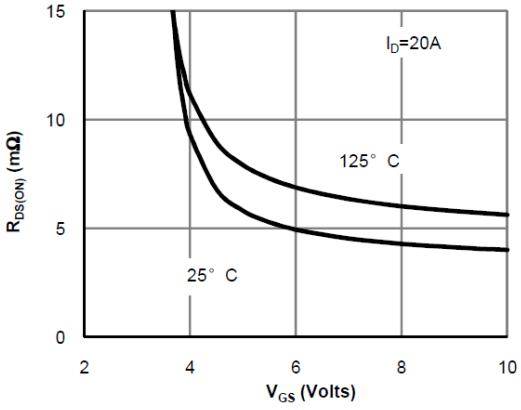


Figure 6. Body-Diode Characteristics

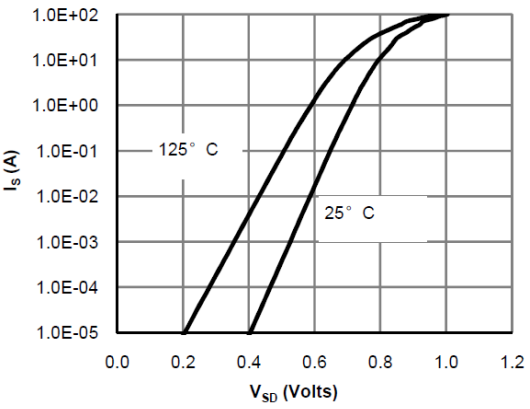


Figure 7. Gate-Charge Characteristics

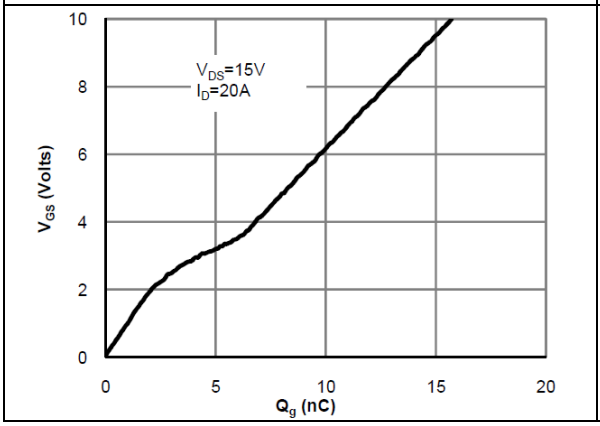


Figure 8. Capacitance Characteristics

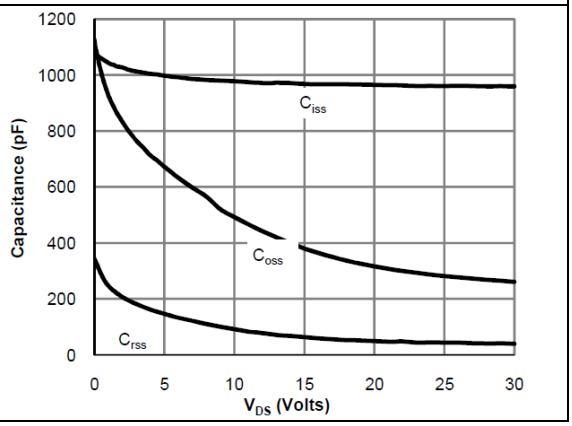


Figure 9. Maximum Forward Biased Safe Operating Area

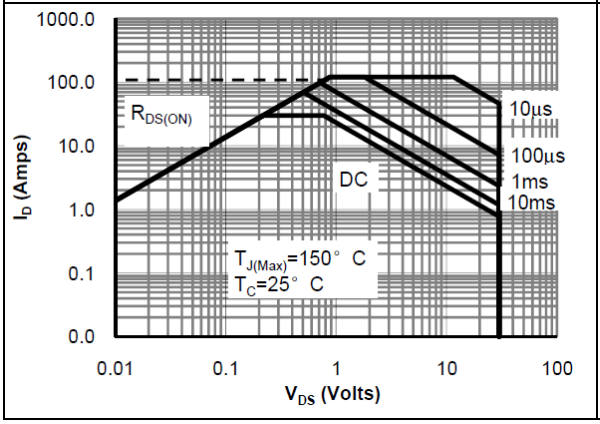


Figure 10. Single Pulse Power Rating Junction-to-Case

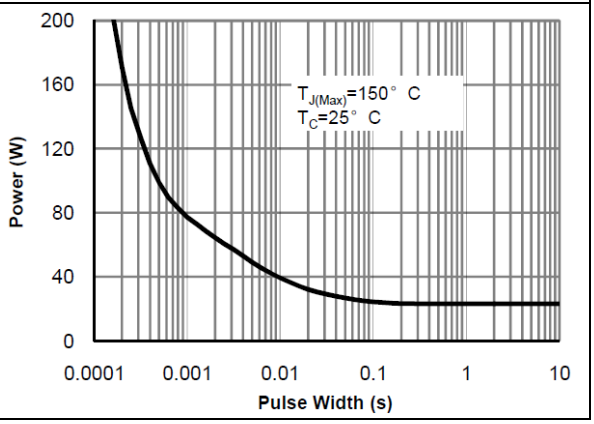


Figure 11. Normalized Maximum Transient Thermal Impedance

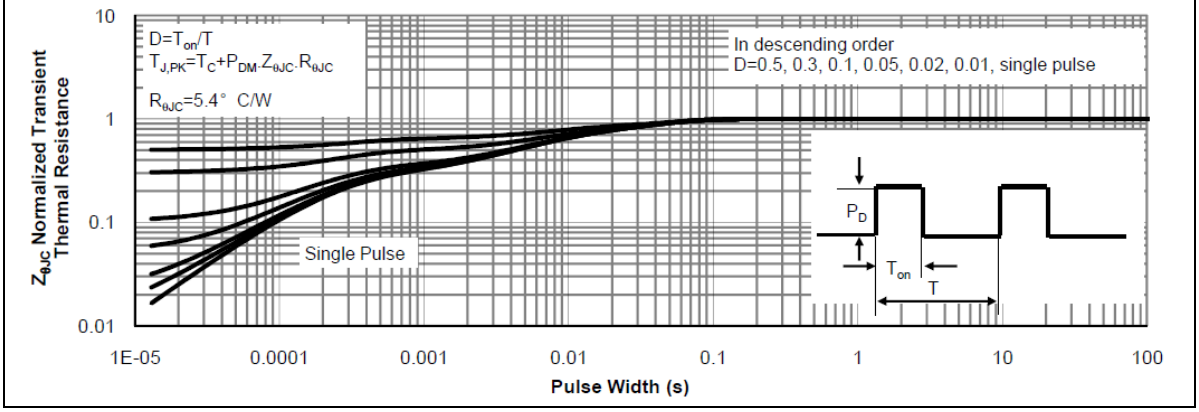


Figure 12. Power De-rating

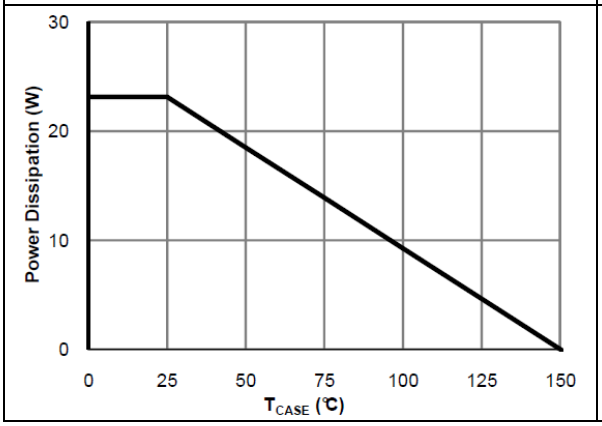


Figure 13. Current De-rating

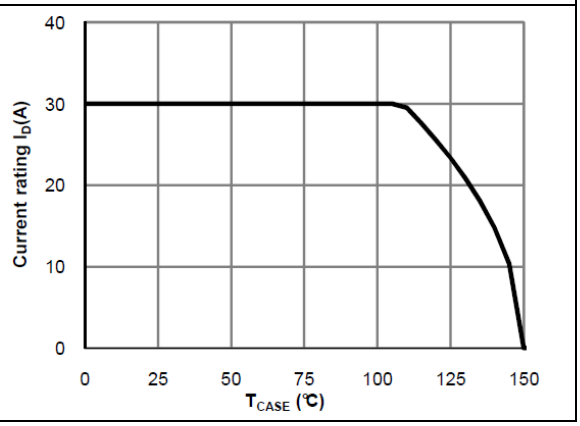


Figure 14. Single Pulse Power Rating Junction-to-Ambient

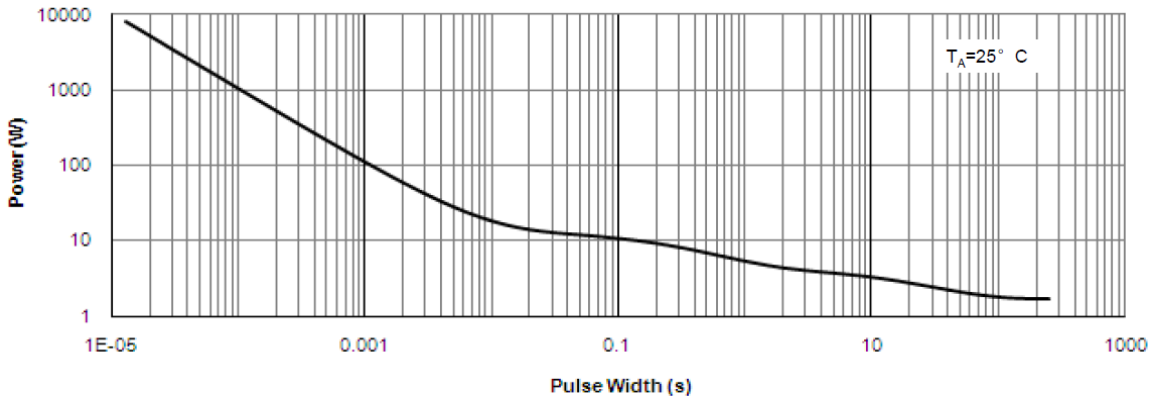
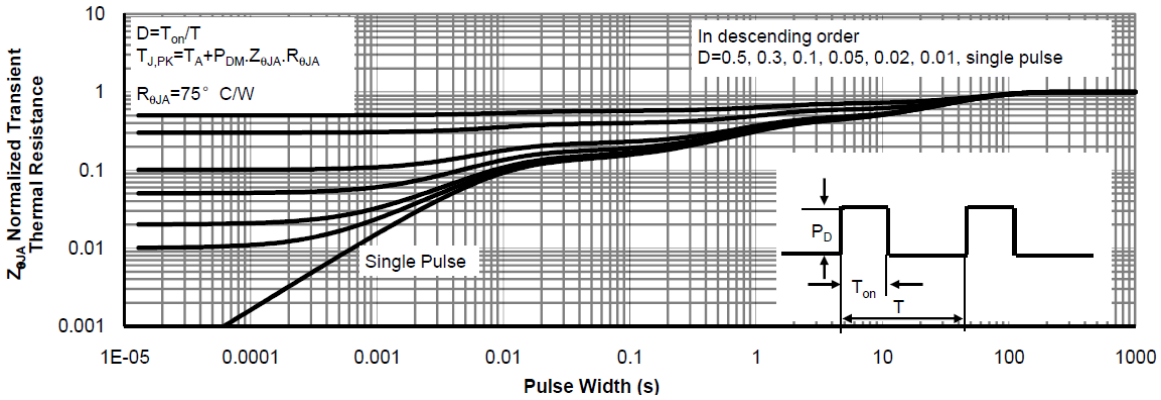
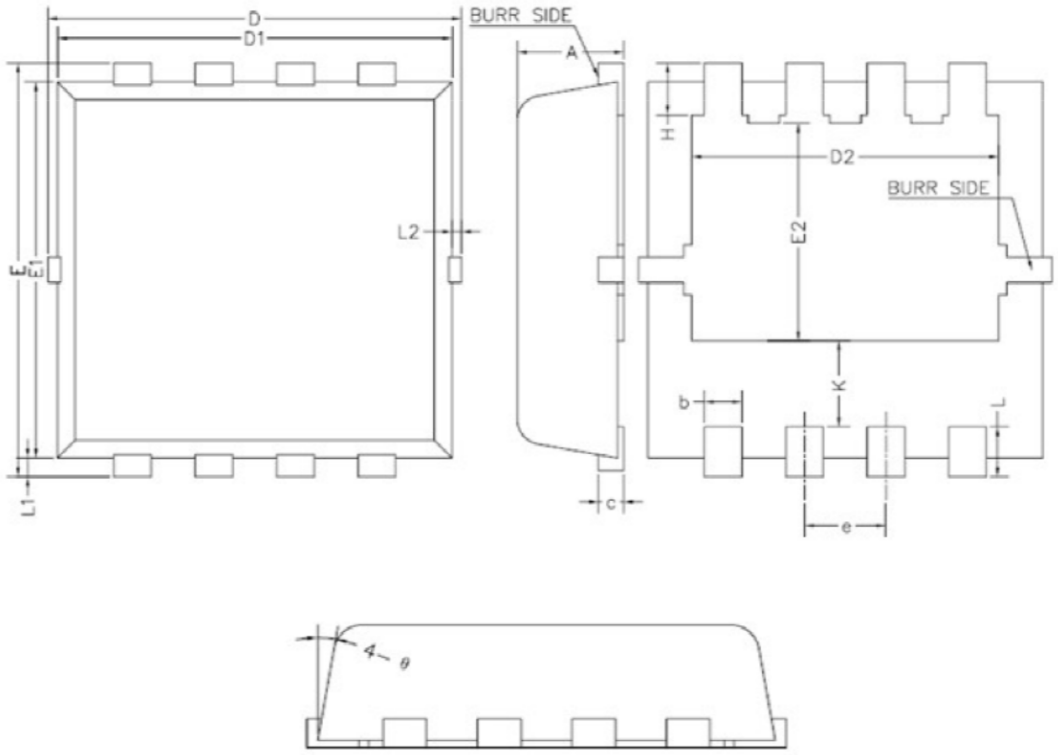


Figure 15. Normalized Maximum Transient Thermal Impedance



Physical Dimensions

PDFN5060



符号	尺寸（mm）			符号	尺寸（mm）		
	最小值	典型值	最大值		最小值	典型值	最大值
A	0.90	1.00	1.10	E1	5.70	5.75	5.80
b	0.33	0.41	0.51	E2	3.38	3.58	3.78
c	0.20	0.25	0.30	H	0.41	0.51	0.61
D	4.80	4.90	5.00	K	1.10	-	-
D1	3.61	3.81	3.96	L	0.51	0.61	0.71
e	1.27BSC			L1	0.06	0.13	0.20
E	5.90	6.00	6.10	θ	0°	-	12°